	COUNT	DESCRIPTION OF REVI		SIONS	ONS BY CHKD DA		DATE			IT DESC	DESCRIPTION OF REV		VISIONS BY		CH	(D D	ATE
Δ										+							
	PLICAF	BLE STANDARD)					ΙΔ									
AIILIOAI		Operating	−55°C to 105°C			5°C (No	Te		Storage	torage emperature Range torage Humidity ange		-10°C +0 +60°C (I			` (Note	Note3)	
		Temperature Rar Operating Humid				0 0 (110						-10°C to +60°C (Note3)				0 /	
RΔ	TING	Range	20% to 80% (N				% (Note:	NOTEZ)				40% to 70% (Note3)					
KATING		Applicable Conn	ctor DF51K-30DS-2C(###)							AWG 30 : 0.5A AWG 26 : 1.5A AWG 22-24 : 2		AWG 30 : 0.5A AWG 28 : 1.0A					
		Voltage							Current			.0A	DA AC				
		_	SPECIFICATIONS														
		ITEM			TES						R	EQUIR	EMENT:	<u>s</u>		QT	AT
CO		UCTION	TEST METHOD REQUIREMENTS														
Gene	eral Exar	nination	Visually and by measuring instrument.									0	0				
Marking			Confirmed visually. According to drawing.									0	0				
ELE	CTRI	CAL CHARAC	TERI	STICS	3												
	act Res		20mV MAX, 1mA (DC or 1000Hz). 30 mΩ MAX.									١٥	l _				
		el Method															
Insul	ation Re	sistance	500 V DC.							1,000	1,000 MΩ MIN.				0	-	
Volta	age Prod	f	650 V AC for 1 min.							No fla	No flashover or breakdown.				0	-	
MF	CHAN	ICAL CHARAC	TFR	ISTIC	S												
		Operation	30 times insertion and extraction.						①Cor	①Contact resistance: 30mΩ MAX							
		(Sn Plating)	OU UITIGO ITIOGI UOTI ATTU EXILACTIOTI.							_	②No damage, crack or looseness of parts.				0	-	
Mack	nanical ()peration								①Cor	①Contact resistance: 30mΩ MAX ②No damage, crack or looseness of parts. ①Insertion Force: 128.2N MAX				-		
MECI	iariicai C	(Au Plating)								_					0	-	
										(1)					_		
Matir force		nmating (Sn Plating)	It takes out and inserts with a conformity connector.							Ŭ	②Extraction Force: 7.7N MIN				0	-	
	ng and u		It takes out and inserts with a conformity connector.								12						
force	•	(Au Plating)								(2)Exti	②Extraction Force: 7.5N MIN				0	-	
Vibra	ation		Frequency 10 to 55 Hz, single amplitude 0.75 mm, at 10 cycles for 3 direction.								①No electrical discontinuity of 1 μ s. ②No damage, crack or looseness of parts.					0	-
Shock			Acceleration 490 m/s ² duration of pulse 11 ms at 3								_ •						
			times for 3 directions.													0	-
 ENVIRONMENTAL CHARACTERISTICS					<u> </u>					<u> </u>					1		
_					at 40 ± 2 °C , humidity 90 to 95 %, 96 h.					n. ①Cor	①Contact resistance: 30 mΩ MAX.						
(Steady State)			(After leaving the room temperature for 1 to 2h.)							②Insu	②Insulation resistance: 500MΩ MIN.					0	-
_									③No	③No damage, crack or looseness of parts.							
Rema		de the temperature	rising	hy curr	ent												
		ondensing	rionig	by curr	OTTC.												
Note		y to the condition o	_		_		-			cb on boa	rd, after p	cb board	d , operati	ng temp	eratı	ure and	
	hum	dity range is applie	d for ir	iterim s	torage	during t	ransport	ation	-								
							DRAWN DESI		DESIG	DESIGNED CHECKE		ED APPROVED		RELEA	RELEASED		
						J	.s c	НО	J.S C	J.S CHO S.M.I				$\overline{}$	ENG 2023.07.24		
					2	1.05.	14	21.05	21.05.14 21.05.14				DEF	——/			
Unless otherwise specified, refer to IEC 60512. NOTE QT: QUALIFICATION TEST AT: ASSURANCE TEST O: APPLICABLE TEST																	
NUI	PART NO.																
HIROSE KOREA CO.,LTD. SPECIFIC						CIFICA	CATION SHEET			DF51K-30DP-2V(800)							
CODE NO.(OLD)				DRAWI	WING NO. CODE NO			NO.					1/				
CL				ELC4-633527						GL 0052-00/8-6-800					/ 2		

Rapid Change of	Temperature $-55 ^{\circ}\text{C} \rightarrow +105 ^{\circ}\text{C}$	①Contact resistance: 30 mΩ MAX.				
Temperature	Time 30min → 30min	②Insulation resistance: 1,000 $M\Omega$ MIN.	0	-		
	Under 5 Cycles.	3No damage, crack or looseness of parts.				
	(The transferring time of the tank is 2 to 3 MIN)					
	(After leaving the room temperature for 1 to 2h.)					
Dry Heat	Exposed at 105±2 °C, 96h	①Contact resistance: 30 mΩ MAX.				
		②Insulation resistance: 1,000MΩ MIN.	0	-		
		③No damage, crack or looseness of parts.				
Cold	Exposed at −55±3 °C, 96h	①Contact resistance: 30 mΩ MAX.				
		②Insulation resistance: 1,000MΩ MIN.	0	-		
		③No damage, crack or looseness of parts.				
Resistance To Soldering	Reflow time	No deformation of case of excessive looseness				
Heat	Number of reflow cycles : 2cycles MAX	of the terminals.				
	Duration above 220°C, 60sec. MAX.		0	-		
	Peak temperature : 250°C 10sec. MAX					
Solderability	Soldering temperature: 245 °C	New uniform coating of solder shall cover				
	Duration of immersion :soldering, for 5 sec.	minimum of 95 % of the surface Being	0	-		
		immersed.				
Recommended						
Temperature Profile	REFLOW TEMPERATURE PROFILE USING LEAD-FREE SOLDER PASTE	<u>(REFERENCE)</u>				
	f(°C)10s MAX					
	250	BER OF REFLOW CYCLES 2CYCLES MAX.				
		TEMPERATURE IS MEASURED IN THE TERMINAL LEAD PART.				
	200	TERRESTORIE O TERRESTORIA TERRESTORIA ESPERANTE				
	60s MAX ADD	ITIONAL FACTORS, SUCH AS SOLDER PASTE TYPE,				
	150 90-120s PCB	SIZE AND OTHER MOUNTED COMPONENTS COULD AFFECT				
	100/	PROFILES. THEREFORE, A THOROUGH EVALUATION OF				
	MOU	NTING CONDITION IS REQUIRED PRIOR TO PRODUCTION.				
	 					
	(s)					

NOTE QT: QUALIFICATION TEST AT: ASSURANCE TEST O: APPLICABLE TEST										
LUDOOF KODEA OO LED			OUEET	PART NO.						
HIROSE KOREA CO.,LTD	·	SPECIFICATION	SHEET	DF51K-30DP-2V(800)						
CODE NO.(OLD)	DRAWING NO	0.	CODE NO.	CL 6652-0078-6-800	2 /					
CL	EI	LC4-633527		GL 0032-0078-0-600	/ 2					